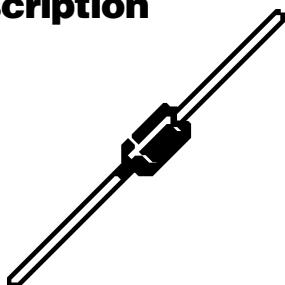
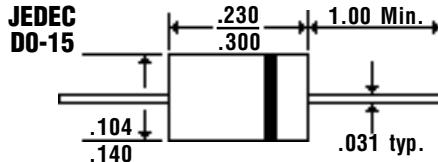
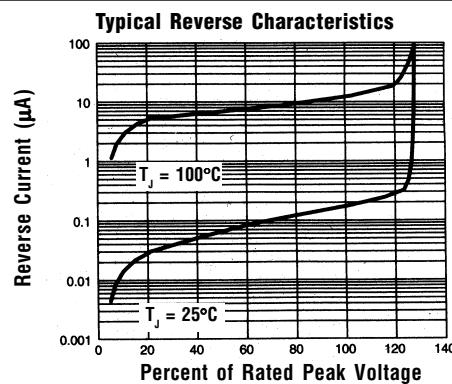
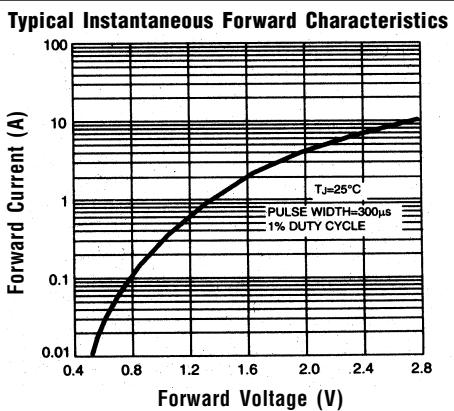
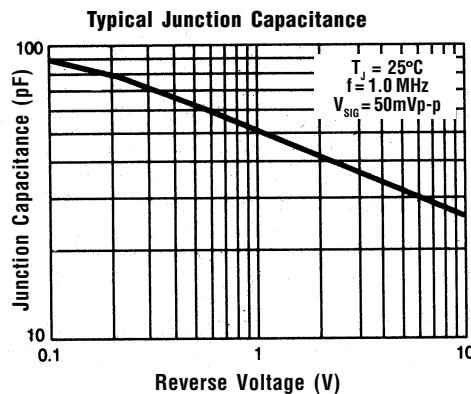
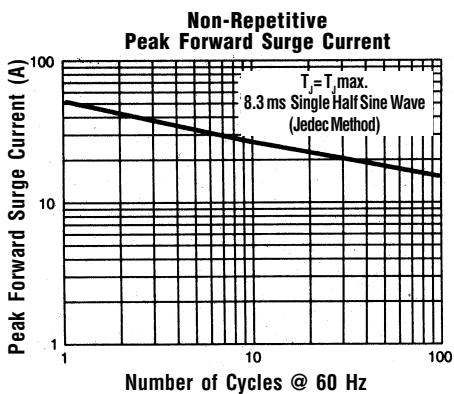
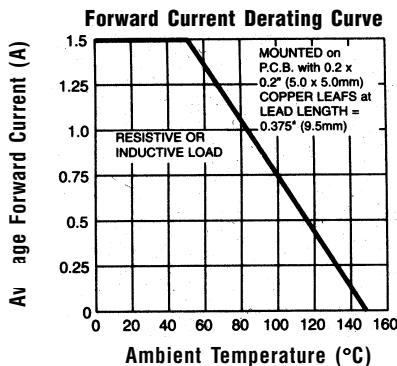


Description

Mechanical Dimensions

Features

- **HIGH TEMPERATURE METALLURGICALLY BONDED CONSTRUCTION**
- **SINTERED GLASS CAVITY-FREE JUNCTION**
- **1.5 AMP OPERATION @ $T_A = 55^\circ\text{C}$, WITH NO THERMAL RUNAWAY**
- **TYPICAL $I_R < 0.2 \mu\text{Amp}$**

	GUF15A . . . 15M Series								Units
Maximum Ratings	GUF 15A	GUF 15B	GUF 15D	GUF 15F	GUF 15G	GUF 15J	GUF 15K	GUF 15M	
Peak Repetitive Reverse Voltage... V_{RRM}	50	100	200	300	400	600	800	1000	Volts
RMS Reverse Voltage... $V_{R(rms)}$	35	70	140	210	280	420	560	700	Volts
DC Blocking Voltage... V_{DC}	50	100	200	300	400	600	800	1000	Volts
Average Forward Rectified Current... $I_{F(av)}$ 3/8" Lead Length @ $T_A = 55^\circ\text{C}$					1.5				Amps
Non-Repetitive Peak Forward Surge Current... I_{FSM} 8.3ms, ½ Sine Wave Superimposed on Rated Load					50				Amps
Operating & Storage Temperature Range... T_J , T_{STRG}					-65 to 175				°C
Electrical Characteristics									
Maximum Forward Voltage @ 1.5A ... V_F	< 1.1 >	< 1.4 >	< 1.7 >						Volts
Maximum Full Load Reverse Current... $I_R(\text{av})$ Full Cycle Average @ $T_A = 55^\circ\text{C}$					100				µAmps
Maximum DC Reverse Current... I_R @ Rated DC Blocking Voltage	$T_A = 25^\circ\text{C}$				10				µAmps
	$T_A = 125^\circ\text{C}$				100				µAmps
Typical Junction Capacitance... C_J (Note 1)	< 40 >	< 50 >							pF
Typical Thermal Resistance... $R_{\theta JA}$ (Note 2)					20				°C/W
Maximum Reverse Recovery Time... t_{RR} (Note 3)	< 50 >	< 75 >							ns



Ratings at
25 Deg. C ambient
temperature
unless otherwise
specified.

Single Phase Half
Wave, 60 Hz
Resistive or
Inductive Load.

For Capacitive
Load, Derate
Current by 20%.

- NOTES:**
1. Measured @ 1 MHz and applied reverse voltage of 4.0V.
 2. Thermal Resistance from Junction to Ambient at 3/8" Lead Length, P.C. Board Mounted.
 3. Reverse Recovery Condition $I_F = 0.5A$, $I_R = 1.0A$, $I_{RR} = 0.25A$.